

TRIPLE PLL FIELD PROGRAMMABLE VCXO CLOCK SYNTHESIZER

ICS271

Description

The ICS271 field programmable VCXO clock synthesizer generates up to six high-quality, high-frequency clock outputs including multiple reference clocks from a low-frequency crystal input. It is designed to replace crystals and crystal oscillators in most electronic systems.

Using IDT's VersaClockTM software to configure PLLs and outputs, the ICS271 contains a One-Time Programmable (OTP) ROM for field programmability. Programming features include VCXO, eight selectable configuration registers and up to two sets of three low-skew outputs.

Each of the two output groups are powered by a separate VDDO voltage. VDDO may vary from 1.8 V to VDD.

Using Phase-Locked Loop (PLL) techniques, the device runs from a standard fundamental mode, inexpensive crystal, or clock. It can replace VCXOs, multiple crystals and oscillators, saving board space and cost.

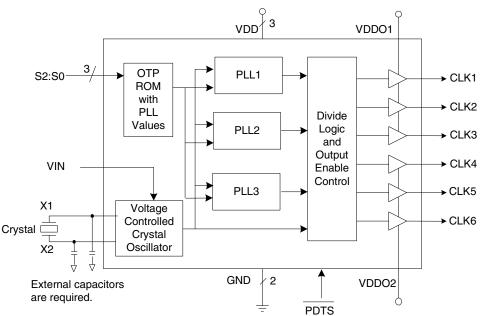
The ICS271 is also available in factory programmed custom versions for high-volume applications.

Features

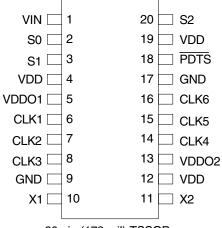
- · Packaged as 20-pin TSSOP
- · Eight addressable registers
- · Replaces multiple crystals and oscillators
- Output frequencies up to 200 MHz at 3.3 V
- Input crystal frequency of 5 to 27 MHz
- Up to six reference outputs
- Separate 1.8 to 3.3 V VDDO output level controls for each bank of 3 outputs
- Up to two sets of three low-skew outputs
- Operating voltages of 3.3 V
- · Controllable output drive levels
- Advanced, low-power CMOS process
- Available in Pb (lead) free packaging

NOTE: EOL for non-green parts to occur on 5/13/10 per PDN U-09-01

Block Diagram



Pin Assignment



20 pin (173 mil) TSSOP

Pin Descriptions

Pin Number	Pin Name	Pin Type	Pin Description
1	VIN	Input	Voltage input to VCXO. Zero to 3.3 V signal which controls the VCXO frequency
2	S0	Input	Select pin 0. Internal pull-up resistor.
3	S1	Input	Select pin 1. Internal pull-up resistor.
4	VDD	Power	Connect to +3.3 V.
5	VDDO1	Power	Power supply for outputs CLK1-CLK3. Must not exceed VDD.
6	CLK1	Output	Output clock 1. Weak internal pull-down when tri-state.
7	CLK2	Output	Output clock 2. Weak internal pull-down when tri-state.
8	CLK3	Output	Output clock 3. Weak internal pull-down when tri-state.
9	GND	Power	Connect to ground.
10	X1	XI	Crystal input. Connect this pin to a crystal.
11	X2	XO	Crystal Output. Connect this pin to a crystal.
12	VDD	Power	Connect to +3.3 V.
13	VDDO2	Power	Power supply for outputs CLK4-CLK6. Must not exceed VDD.
14	CLK4	Output	Output clock 4. Weak internal pull-down when tri-state.
15	CLK5	Output	Output clock 5. Weak internal pull-down when tri-state.
16	CLK6	Output	Output clock 6. Weak internal pull-down when tri-state.
17	GND	Power	Connect to ground.
18	PDTS	Input	Power-down tri-state. Powers down entire chip and tri-states clock outputs when low. Internal pull-up resistor.
19	VDD	Power	Connect to +3.3 V.
20	S2	Input	Select pin 2. Internal pull-up resistor.

External Components

The ICS271 requires a minimum number of external components for proper operation.

Series Termination Resistor

Clock output traces over one inch should use series termination. To series terminate a $50\Omega\,\text{trace}$ (a commonly used trace impedance), place a $33\Omega\,\text{resistor}$ in series with the clock line, as close to the clock output pin as possible. The nominal impedance of the clock output is 20Ω

Decoupling Capacitors

As with any high-performance mixed-signal IC, the ICS271 must be isolated from system power supply noise to perform optimally.

Decoupling capacitors of 0.01µF must be connected between each VDD, VDDO, and the PCB ground plane. For optimum device performance, the decoupling capacitor should be mounted on the component side of the PCB. Avoid the use of vias on the decoupling circuit.

Quartz Crystal

The ICS271 VCXO function consists of the external crystal and the integrated VCXO oscillator circuit. To assure the best system performance (frequency pull range) and reliability, a crystal device with the recommended parameters (shown below) must be used, and the layout guidelines discussed in the following section shown must be followed.

The frequency of oscillation of a quartz crystal is determined by its "cut" and by the load capacitors connected to it. The ICS271 incorporates on-chip variable load capacitors that "pull" (change) the frequency of the crystal. The crystal specified for use with the ICS271 is designed to have zero frequency error when the total of on-chip + stray capacitance is 14 pF.

Recommended Crystal Parameters:

Initial Accuracy at 25° C	±20 ppm
Temperature Stability	±30 ppm
Aging	±20 ppm
Load Capacitance	14 pf
Shunt Capacitance, C0	7 pF Max
C0/C1 Ratio	250 Max
Equivalent Series Resistance	$35\Omega\mathrm{Max}$

The external crystal must be connected as close to the chip as possible and should be on the same side of the PCB as the ICS271. There should be no via's between the crystal pins and the X1 and X2 device pins. There should be no signal traces underneath or close to the crystal. See application note MAN05.

Crystal Tuning Load Capacitors

The crystal traces should include pads for small fixed capacitors, one between X1 and ground, and another between X2 and ground. Stuffing of these capacitors on the PCB is optional. The need for these capacitors is determined at system prototype evaluation, and is influenced by the particular crystal used (manufacture and frequency) and by PCB layout. The typical required capacitor value is 1 to 4 pF.

To determine the need for and value of the crystal adjustment capacitors, you will need a PC board of your final layout, a frequency counter capable of about 1 ppm resolution and accuracy, two power supplies, and some samples of the crystals which you plan to use in production, along with measured initial accuracy for each crystal at the specified crystal load capacitance, CL.

To determine the value of the crystal capacitors:

- 1. Connect VDD of the ICS271 to 3.3 V. Connect pin 1 of the ICS271 to the second power supply. Adjust the voltage on pin 1 to 0V. Measure and record the frequency of the CLK output.
- 2. Adjust the voltage on pin 1 to 3.3 V. Measure and record the frequency of the same output.

To calculate the centering error:

Error =
$$10^6 x \left[\frac{(f_{3.0V} - f_{target}) + (f_{0V} - f_{target})}{f_{target}} \right] - error_{xtal}$$

Where:

f_{target} = nominal crystal frequency

error_{xtal} =actual initial accuracy (in ppm) of the crystal being measured

If the centering error is less than ± 25 ppm, no adjustment is needed. If the centering error is more than 25 ppm negative, the PC board has excessive stray capacitance and a new PCB layout should be considered to reduce stray capacitance. (Alternately, the crystal may be re-specified to a higher load capacitance. Contact IDT for details.) If the centering error is more than 25 ppm positive, add identical fixed centering capacitors from each crystal pin to ground. The value for each of these caps (in pF) is given by: External Capacitor = 2 x (centering error)/(trim sensitivity)

Trim sensitivity is a parameter which can be supplied by your crystal vendor. If you do not know the value, assume it is 30 ppm/pF. After any changes, repeat the measurement to verify that the remaining error is acceptably low (typically less than ±25 ppm).

ICS271 Configuration Capabilities

The architecture of the ICS271 allows the user to easily configure the device to a wide range of output frequencies, for a given input reference frequency.

The frequency multiplier PLL provides a high degree of precision. The M/N values (the multiplier/divide values available to generate the target VCO frequency) can be set within the range of M = 1 to 1024 and N = 1 to 32,895.

The ICS271 also provides separate output divide values, from 2 through 63, to allow the two output clock banks to support widely differing frequency values from the same PLL.

Each output frequency can be represented as:

OutputFreq = REFFreq
$$\cdot$$
 $\frac{M}{N}$

Each output clock bank has an separate voltage drive control pin (VDDO1 and VDDO2) that sets the output clock voltage swing.

Output Drive Control

The ICS271 has two output drive settings. For VDDO=VDD, low drive should be selected when outputs are less than 100 MHz. High drive should be selected when outputs are greater than 100 MHz.

For VDDO<2.8 V, high drive should be selected for all output frequencies.

(Consult the AC Electrical Characteristics for output rise and fall times for each drive option.)

IDT VersaClock Software

IDT applies years of PLL optimization experience into a user friendly software that accepts the user's target reference clock and output frequencies and generates the lowest jitter, lowest power configuration, with only a press of a button. The user does not need to have prior PLL experience or determine the optimal VCO frequency to support multiple output frequencies.

VersaClock software quickly evaluates accessible VCO frequencies with available output divide values and provides an easy to understand, bar code rating for the target output frequencies. The user may evaluate output accuracy, performance trade-off scenarios in seconds.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the ICS271. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Parameter	Condition	Min.	Тур.	Max.	Units
Supply Voltage, VDD	Referenced to GND			7	V
Inputs	Referenced to GND	-0.5		VDD+0.5	V
Clock Outputs	Referenced to GND	-0.5		VDD+0.5	V
Storage Temperature		-65		150	°C
Soldering Temperature	Max 10 seconds			260	°C
Junction Temperature				125	°C

Recommended Operation Conditions

Parameter	Min.	Тур.	Max.	Units
Ambient Operating Temperature (commercial)	0		+70	°C
Ambient Operating Temperature (industrial)	-40		+85	°C
Power Supply Voltage (measured in respect to GND)	+3.135	+3.3	+3.465	V
Power Supply Ramp Time			4	ms
Reference crystal parameters		Refer to	page 3	

DC Electrical Characteristics

Unless stated otherwise, VDD, VDDO = 3.3 V ±5%, Ambient Temperature -40 to +85° C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Operating Voltage	VDD		3.135		3.465	V
VDDO Voltage		VDDO1 and VDDO2	1.80		VDD	V
		Config. Dependent - See VersaClock TM Estimates.				mA
Operating Supply Current Input High Voltage	IDD	Six 33.3333 MHz outs, VDD=VDDO=3.3 V; PDTS = 1, no load, Note 1		25		mA
		PDTS = 0, no load		500		μΑ
Input High Voltage	V _{IH}	S2:S0	VDD/2+1			V
Input Low Voltage	V _{IL}	S2:S0			0.4	V
Input High Voltage, PDTS	V _{IH}		VDD-0.5			V
Input Low Voltage, PDTS	V _{IL}				0.4	V

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Input High Voltage	V_{IH}	ICLK	VDD/2+1			V
Input Low Voltage	V_{IL}	ICLK			VDD/2-1	V
Output High Voltage (CMOS High)	V _{OH}	I _{OH} = -4 mA	VDD-0.4			V
Output High Voltage	V _{OH}	I _{OH} = -8 mA (Low Drive); I _{OH} = -12 mA (High Drive)	2.4 VDDO-0.4			V
Output Low Voltage	V _{OL}	I _{OL} = 8 mA (Low Drive); I _{OL} = 12 mA (High Drive)			0.4	V
Short Circuit Current	Ios	Low Drive		±40		
		High Drive		±70		mA
Nom. Output Impedance	Z _O			20		Ω
Internal pull-up Resistor	R _{PUS}	S2:S0, PDTS		190		kΩ
Internal pull-down Resistor	R _{PD}	CLK outputs		120		kΩ
Input Capacitance	C _{IN}	Inputs		4		pF

Note 1: Example with 25 MHz crystal input with six outputs of $33.\overline{3}$ MHz, no load, and VDD = 3.3 V.

AC Electrical Characteristics

Unless stated otherwise, VDD, VDDO = 3.3 V ±5%, Ambient Temperature -40 to +85° C

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Input Frequency	F _{IN}	Fundamental crystal	5		27	MHz
Output Frequency		VDDO=VDD	0.314		200	MHz
		1.8V <u><</u> VDDO <u><</u> 2.8	0.314		150	MHz
Crystal Pullability	F _P	0V≤ VIN ≤ 3.3 V, Note 1, Config. Dependent	100			ppm
VCXO Gain		VIN = VDD/2 ± 1 V, Note 1, Config. Dependent		120		ppm/V
Output Rise/Fall Time	t _{OF}	80% to 20%, high drive, Note 2		1.0		ns
Output Rise/Fall Time	t _{OF}	80% to 20%, low drive, Note 2		2.0		ns
Output Rise/Fall Time	t _{OF}	80% to 20%, high drive, 1.8 V≤VDDO≤2.8 Note 2		2.0		ns
Output Clock Duty Cycle		VDDO = 3.3 V, Note 3	40	49-51	60	%
Output Frequency Synthesis Error		Configuration Dependent		TBD	,	ppm

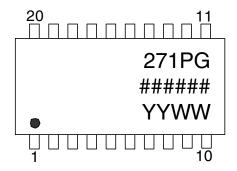
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Power-up time		PLL lock-time from power-up		4	10	ms
		PDTS goes high until stable CLK output		0.6	2	ms
One Sigma Clock Period Jitter		Configuration Dependent		50		ps
Maximum Absolute Jitter	t _{ja}	Deviation from Mean. Configuration Dependent		<u>+</u> 200		ps
Pin-to-Pin Skew		Low Skew Outputs	-250		250	ps

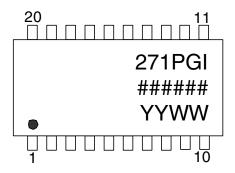
- Note 1: External crystal device must conform with Pullable Crystal Specifications listed on page 3.
- Note 2: Measured with 15 pF load, VDDO = 3.3 V at VDDO/2.
- Note 3: Duty Cycle is configuration dependent. Most configurations are min 45% / max 55%

Thermal Characteristics

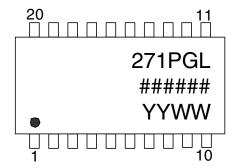
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Thermal Resistance Junction to	θ_{JA}	Still air		93		° C/W
Ambient	θ_{JA}	1 m/s air flow		78		° C/W
	θ_{JA}	3 m/s air flow		65		° C/W
Thermal Resistance Junction to Case	θ_{JC}			20		° C/W

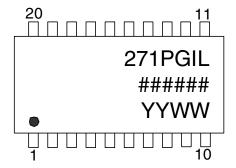
Marking Diagrams





Marking Diagrams (Pb free)



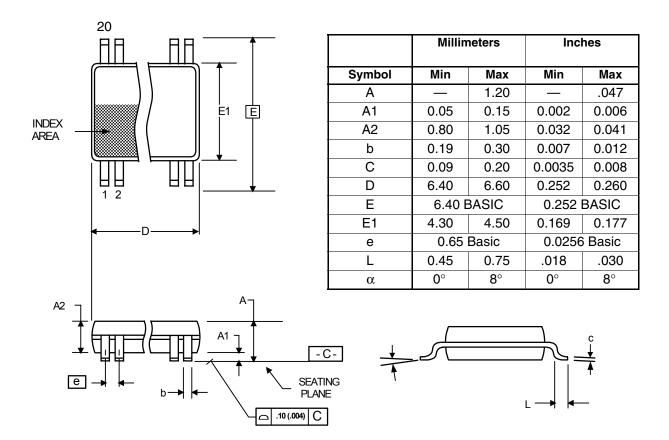


Notes:

- 1. ##### is the lot number.
- 2. YYWW is the last two digits of the year and week that the part was assembled.
- 3. "I" denotes industrial temperature range (if applicable).
- 4. "L" denotes Pb (lead) free package.
- 5. Bottom marking: country of origin.

Package Outline and Package Dimensions (20-pin TSSOP, 173 Mil. Body)

Package dimensions are kept current with JEDEC Publication No. 95



Ordering Information

Part / Order Number	Marking	Shipping Packaging	Package	Temperature
271PG*		Tubes	20-pin TSSOP	0 to +70° C
271PGI*	See page 7	Tubes	20-pin TSSOP	-40 to +85° C
271PGLF		Tubes	20-pin TSSOP	0 to +70° C
271PGILF		Tubes	20-pin TSSOP	-40 to +85° C
271G-XX*	271G-XX	Tubes	20-pin TSSOP	0 to +70° C
271GI-XX*	271GIXX	Tubes	20-pin TSSOP	-40 to +85° C
271G-XXLF	271GXXL	Tubes	20-pin TSSOP	0 to +70° C
271GI-XXLF	271GIXXL	Tubes	20-pin TSSOP	-40 to +85° C
271G-XXT*	271G-XX	Tape and Reel	20-pin TSSOP	0 to +70° C
271GI-XXT*	271GIXX	Tape and Reel	20-pin TSSOP	-40 to +85° C
271G-XXLFT	271GXXL	Tape and Reel	20-pin TSSOP	0 to +70° C
271GI-XXLFT	271GIXXL	Tape and Reel	20-pin TSSOP	-40 to +85° C

*NOTE: EOL for non-green parts to occur on 5/13/10 per PDN U-09-01

Parts that are ordered with a "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

The 271G-XX, 271G-XXLF, 271GI-XX, and 271GI-XXLF are factory programmed versions of the 271PG, 271PGLF, 271PGI, and 271PGILF. A unique "-XX" suffix is assigned by the factory for each custom configuration, and a separate data sheet is kept on file. For more information on custom part numbers programmed at the factory, please contact your local IDT sales and marketing representative.

While the information presented herein has been checked for both accuracy and reliability, IDT assumes no responsibility for either its use or for the infringement of any patents or other rights of third parties, which would result from its use. No other circuits, patents, or licenses are implied. This product is intended for use in normal commercial applications. Any other applications such as those requiring extended temperature range, high reliability, or other extraordinary environmental requirements are not recommended without additional processing by IDT. IDT reserves the right to change any circuitry or specifications without notice. IDT does not authorize or warrant any IDT product for use in life support devices or critical medical instruments.

VersaClockTM is a trademark of IDT, Inc. All rights reserved.

Innovate with IDT and accelerate your future networks. Contact:

www.IDT.com

For Sales

800-345-7015 408-284-8200 Fax: 408-284-2775 For Tech Support

www.idt.com/go/clockhelp

Corporate Headquarters

Integrated Device Technology, Inc. www.idt.com

